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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	2475
Number of Logic Elements/Cells	39600
Total RAM Bits	1161216
Number of I/O	328
Number of Gates	-
Voltage - Supply	1.15V ~ 1.25V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep4ce40f23i7n

For more information, refer to the *External Memory Interfaces in Cyclone IV Devices* chapter.

Configuration

Cyclone IV devices use SRAM cells to store configuration data. Configuration data is downloaded to the Cyclone IV device each time the device powers up. Low-cost configuration options include the Altera EPCS family serial flash devices and commodity parallel flash configuration options. These options provide the flexibility for general-purpose applications and the ability to meet specific configuration and wake-up time requirements of the applications.

Table 1–9 lists which configuration schemes are supported by Cyclone IV devices.

Table 1–9. Configuration Schemes for Cyclone IV Device Family

Devices	Supported Configuration Scheme
Cyclone IV GX	AS, PS, JTAG, and FPP *(1)*
Cyclone IV E	AS, AP, PS, FPP, and JTAG

Note to Table 1–9:

(1) The FPP configuration scheme is only supported by the EP4CGX30F484 and EP4CGX50/75/110/150 devices.

IEEE 1149.6 (AC JTAG) is supported on all transceiver I/O pins. All other pins support IEEE 1149.1 (JTAG) for boundary scan testing.

For more information, refer to the *JTAG Boundary-Scan Testing for Cyclone IV Devices* chapter.

For Cyclone IV GX devices to meet the PCIe 100 ms wake-up time requirement, you must use passive serial (PS) configuration mode for the EP4CGX15/22/30 devices and use fast passive parallel (FPP) configuration mode for the EP4CGX30F484 and EP4CGX50/75/110/150 devices.

For more information, refer to the *Configuration and Remote System Upgrades in Cyclone IV Devices* chapter.

The cyclical redundancy check (CRC) error detection feature during user mode is supported in all Cyclone IV GX devices. For Cyclone IV E devices, this feature is only supported for the devices with the core voltage of 1.2 V.

For more information about CRC error detection, refer to the *SEU Mitigation in Cyclone IV Devices* chapter.

High-Speed Transceivers (Cyclone IV GX Devices Only)

Cyclone IV GX devices contain up to eight full duplex high-speed transceivers that can operate independently. These blocks support multiple industry-standard communication protocols, as well as Basic mode, which you can use to implement your own proprietary protocols. Each transceiver channel has its own pre-emphasis and equalization circuitry, which you can set at compile time to optimize signal integrity and reduce bit error rates. Transceiver blocks also support dynamic reconfiguration, allowing you to change data rates and protocols on-the-fly.

4. Embedded Multipliers in Cyclone IV Devices

CYIV-51004-1.1

Cyclone® IV devices include a combination of on-chip resources and external interfaces that help increase performance, reduce system cost, and lower the power consumption of digital signal processing (DSP) systems. Cyclone IV devices, either alone or as DSP device co-processors, are used to improve price-to-performance ratios of DSP systems. Particular focus is placed on optimizing Cyclone IV devices for applications that benefit from an abundance of parallel processing resources, which include video and image processing, intermediate frequency (IF) modems used in wireless communications systems, and multi-channel communications and video systems.

This chapter contains the following sections:

Embedded Multiplier Block Overview

Figure 4–1 shows one of the embedded multiplier columns with the surrounding logic array blocks (LABs). The embedded multiplier is configured as either one 18 × 18 multiplier or two 9 × 9 multipliers. For multiplications greater than 18 × 18, the Quartus® II software cascades multiple embedded multiplier blocks together. There are no restrictions on the data width of the multiplier, but the greater the data width, the slower the multiplication process.

Figure 4–1. Embedded Multipliers Arranged in Columns with Adjacent LABs

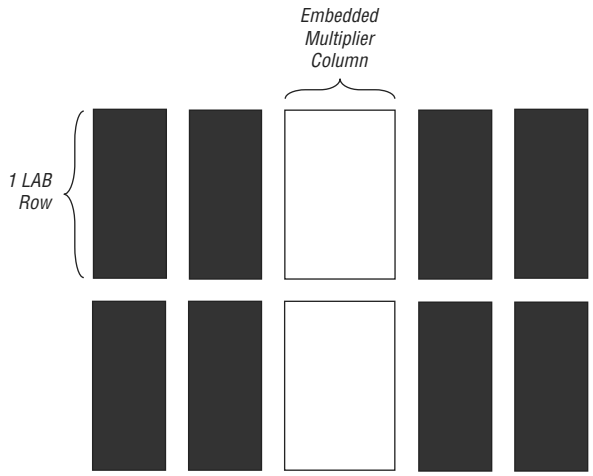
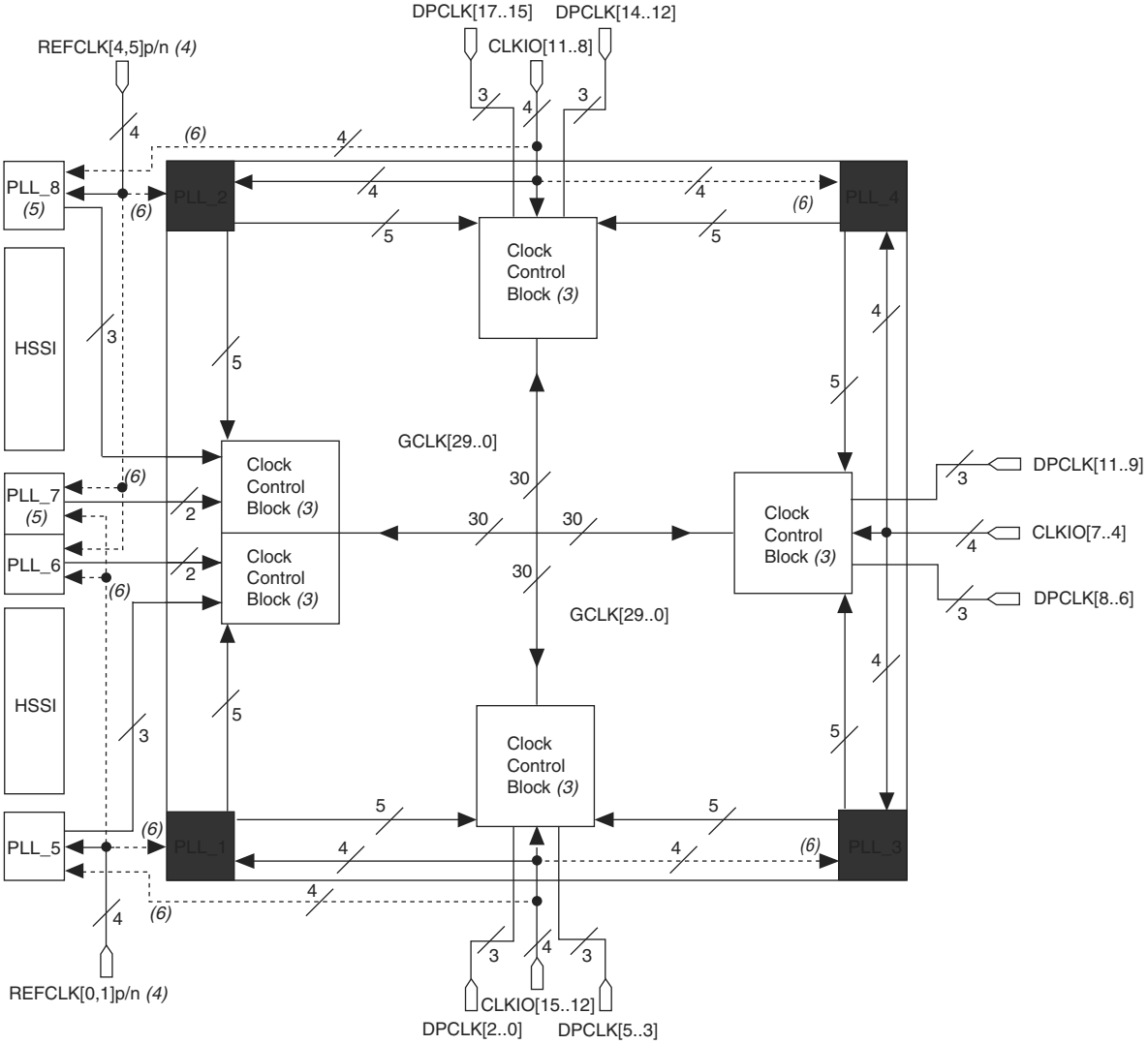


Table 5–2. GCLK Network Connections for EP4CGX30, EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150 Devices (1), (2) (Part 2 of 4)

GCLK Network Clock Sources	GCLK Networks																													
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29
PLL_3_C0	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	✓	—	✓	—	—	—	—	—	—	✓	—	—	✓	—	✓
PLL_3_C1	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	✓	—	—	—	—	—	—	—	—	✓	—	—	✓	—
PLL_3_C2	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	✓	—	—	—	—	—	—	—	—	—	✓	—	✓	—	—	—
PLL_3_C3	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	✓	—	—	—	—	—	—	—	—	—	✓	—	✓	—	—
PLL_3_C4	—	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	✓	✓	—	—	—	—	—	—	—	—	✓	—	✓	✓
PLL_4_C0	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	✓	—	✓	✓	—	—	✓	—	✓	—	—	—	—	—	—
PLL_4_C1	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	✓	—	—	✓	—	—	✓	—	—	—	—	—	—	—
PLL_4_C2	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	✓	—	—	—	✓	—	✓	—	—	—	—	—	—	—	—	—
PLL_4_C3	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	✓	—	—	—	✓	—	✓	—	—	—	—	—	—	—	—
PLL_4_C4	—	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	✓	✓	—	—	✓	—	✓	✓	—	—	—	—	—	—
PLL_5_C0	✓	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_5_C1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_5_C2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_5_C3	—	✓	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_5_C4	—	—	✓	—	✓	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_6_C0	✓	—	—	✓	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_6_C1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_6_C2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_6_C3	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_6_C4	—	✓	—	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_7_C0 (3)	—	—	—	—	—	—	✓	—	—	✓	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_7_C1 (3)	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_7_C2 (3)	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_7_C3 (3)	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
PLL_7_C4 (3)	—	—	—	—	—	—	—	✓	—	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—

Figure 5–3. Clock Networks and Clock Control Block Locations in EP4CGX30, EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150 Devices *(1), (2)*



Notes to Figure 5–3:

(1) The clock networks and clock control block locations in this figure apply to only the EP4CGX30 device in F484 package and all EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150 devices.

(2) `PLL_1`, `PLL_2`, `PLL_3`, and `PLL_4` are general purpose PLLs while `PLL_5`, `PLL_6`, `PLL_7`, and `PLL_8` are multipurpose PLLs.

(3) There are 6 clock control blocks on the top, right and bottom sides of the device and 12 clock control blocks on the left side of the device.

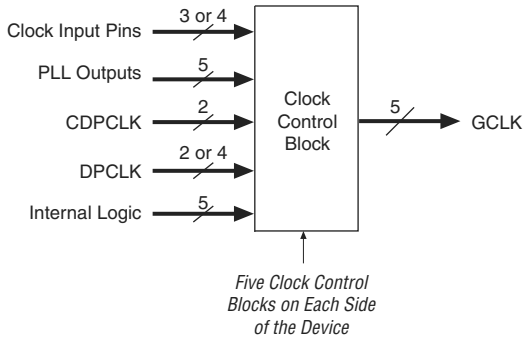
(4) `REFCLK[0,1]p/n` and `REFCLK[4,5]p/n` can only drive the general purpose PLLs and multipurpose PLLs on the left side of the device. These clock pins do not have access to the clock control blocks and GCLK networks. The `REFCLK[4,5]p/n` pins are not available in devices in F484 package.

(5) Not available for EP4CGX30, EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150 devices in F484 package.

(6) Dedicated clock pins can feed into this PLL. However, these paths are not fully compensated.

Figure 5–6 shows a simplified version of the five clock control blocks on each side of the Cyclone IV E device periphery.

Figure 5–6. Clock Control Blocks on Each Side of Cyclone IV E Device *(1)*



Note to Figure 5–6:

(1) The left and right sides of the device have two DPCLK pins; the top and bottom of the device have four DPCLK pins.

GCLK Network Power Down

You can disable a Cyclone IV device's GCLK (power down) using both static and dynamic approaches. In the static approach, configuration bits are set in the configuration file generated by the Quartus II software, which automatically disables unused GCLKs. The dynamic clock enable or disable feature allows internal logic to control clock enable or disable the GCLKs in Cyclone IV devices.

When a clock network is disabled, all the logic fed by the clock network is in an off-state, thereby reducing the overall power consumption of the device. This function is independent of the PLL and is applied directly on the clock network, as shown in Figure 5–1 on page 5–11.

You can set the input clock sources and the clkena signals for the GCLK multiplexers through the Quartus II software using the ALTCLKCTRL megafunction.

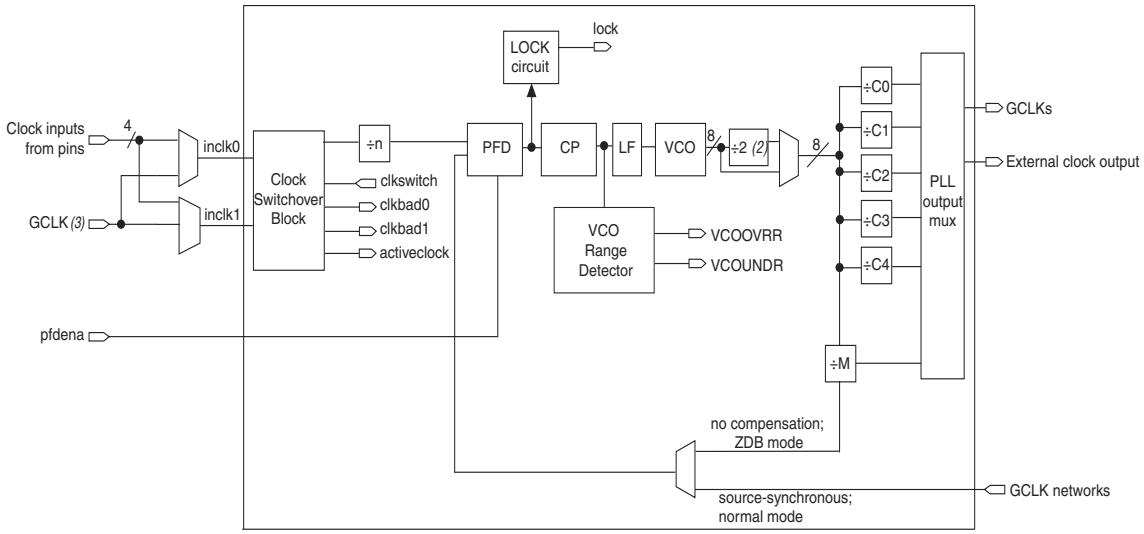
For more information, refer to the *ALTCLKCTRL Megafunction User Guide*.

clkena Signals

Cyclone IV devices support clkena signals at the GCLK network level. This allows you to gate-off the clock even when a PLL is used. Upon re-enabling the output clock, the PLL does not need a resynchronization or re-lock period because the circuit gates off the clock at the clock network level. In addition, the PLL can remain locked independent of the clkena signals because the loop-related counters are not affected.

Figure 5–10 shows a simplified block diagram of the major components of the PLL of Cyclone IV E devices.

Figure 5–10. Cyclone IV E PLL Block Diagram *(1)*



Notes to Figure 5–10:

(1) Each clock source can come from any of the four clock pins located on the same side of the device as the PLL.

(2) This is the VCO post-scale counter K.

(3) This input port is fed by a pin-driven dedicated GCLK, or through a clock control block if the clock control block is fed by an output from another PLL or a pin-driven dedicated GCLK. An internally generated global signal cannot drive the PLL.

☞ The VCO post-scale counter K is used to divide the supported VCO range by two. The VCO frequency reported by the Quartus II software in the PLL summary section of the compilation report takes into consideration the VCO post-scale counter value. Therefore, if the VCO post-scale counter has a value of 2, the frequency reported is lower than the f_{VCO} specification specified in the *Cyclone IV Device Datasheet* chapter.

External Clock Outputs

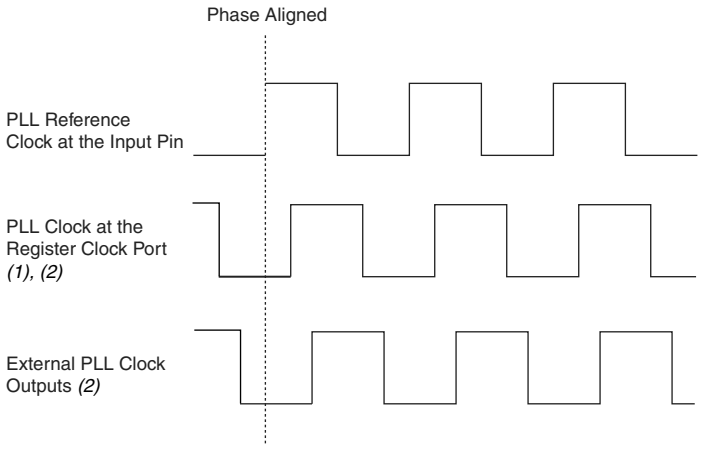
Each PLL of Cyclone IV devices supports one single-ended clock output or one differential clock output. Only the C0 output counter can feed the dedicated external clock outputs, as shown in Figure 5–11, without going through the GCLK. Other output counters can feed other I/O pins through the GCLK.

No Compensation Mode

In no compensation mode, the PLL does not compensate for any clock networks. This provides better jitter performance because clock feedback into the PFD does not pass through as much circuitry. Both the PLL internal and external clock outputs are phase shifted with respect to the PLL clock input.

Figure 5–13 shows a waveform example of the phase relationship of the PLL clock in this mode.

Figure 5–13. Phase Relationship Between PLL Clocks in No Compensation Mode



Notes to Figure 5–13:

(1) Internal clocks fed by the PLL are phase-aligned to each other.

(2) The PLL clock outputs can lead or lag the PLL input clocks.

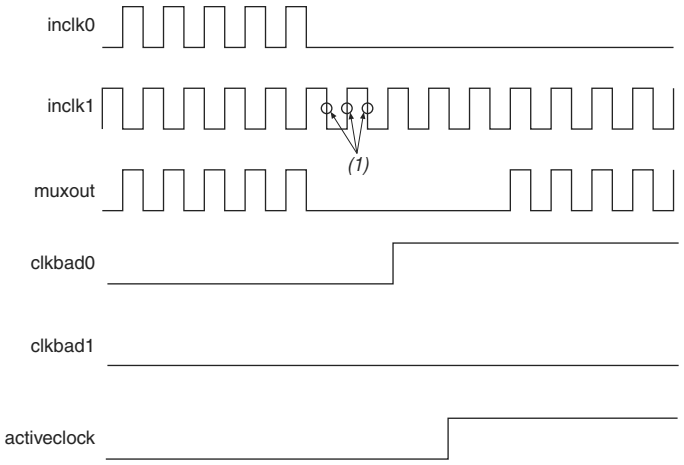
Normal Mode

An internal clock in normal mode is phase-aligned to the input clock pin. The external clock output pin has a phase delay relative to the clock input pin if connected in this mode. The Quartus II software timing analyzer reports any phase difference between the two. In normal mode, the PLL fully compensates the delay introduced by the GCLK network.

20%. This feature is useful when clock sources can originate from multiple cards on the backplane, requiring a system-controlled switchover between frequencies of operation. Choose the secondary clock frequency so the VCO operates in the recommended frequency range. Also, set the M, N, and C counters accordingly to keep the VCO operating frequency in the recommended range.

Figure 5–18 shows a waveform example of the switchover feature when using automatic loss of clock detection. Here, the `inclk0` signal remains low. After the `inclk0` signal remains low for approximately two clock cycles, the clock-sense circuitry drives the `clkbad0` signal high. Also, because the reference clock signal is not toggling, the switchover state machine controls the multiplexer through the `clksw` signal to switch to `inclk1`.

Figure 5–18. Automatic Switchover Upon Clock Loss Detection *(1)*



Note to Figure 5–18:

(1) Switchover is enabled on the falling edge of `inclk0` or `inclk1`, depending on which clock is available. In this figure, switchover is enabled on the falling edge of `inclk1`.

Manual Override

If you are using the automatic switchover, you must switch input clocks with the manual override feature with the `clkswitch` input.

Figure 5–19 shows an example of a waveform illustrating the switchover feature when controlled by `clkswitch`. In this case, both clock sources are functional and `inclk0` is selected as the reference clock. A low-to-high transition of the `clkswitch` signal starts the switchover sequence. The `clkswitch` signal must be high for at least three clock cycles (at least three of the longer clock period if `inclk0` and `inclk1` have different frequencies). On the falling edge of `inclk0`, the reference clock of the counter, `muxout`, is gated off to prevent any clock glitching. On the falling edge of `inclk1`, the reference clock multiplexer switches from `inclk0` to `inclk1` as the PLL reference, and the `activeclock` signal changes to indicate which clock is currently feeding the PLL.

External Memory Interfacing

Cyclone IV devices support I/O standards required to interface with a broad range of external memory interfaces, such as DDR SDRAM, DDR2 SDRAM, and QDR II SRAM.

For more information about Cyclone IV devices external memory interface support, refer to the *External Memory Interfaces in Cyclone IV Devices* chapter.

Pad Placement and DC Guidelines

You can use the Quartus II software to validate your pad and pin placement.

Pad Placement

Altera recommends that you create a Quartus II design, enter your device I/O assignments and compile your design to validate your pin placement. The Quartus II software checks your pin connections with respect to the I/O assignment and placement rules to ensure proper device operation. These rules depend on device density, package, I/O assignments, voltage assignments and other factors that are not fully described in this chapter.

For more information about how the Quartus II software checks I/O restrictions, refer to the *I/O Management* chapter in volume 2 of the *Quartus II Handbook*.

DC Guidelines

For the Quartus II software to automatically check for illegally placed pads according to the DC guidelines, set the DC current sink or source value to **Electromigration Current** assignment on each of the output pins that are connected to the external resistive load.

The programmable current strength setting has an impact on the amount of DC current that an output pin can source or sink. Determine if the current strength setting is sufficient for the external resistive load condition on the output pin.

Clock Pins Functionality

Cyclone IV clock pins have multiple purposes, as per listed:

- `CLK` pins—Input support for single-ended and voltage-referenced standards. For I/O standard support, refer to Table 6–3 on page 6–11.
- `DIFFCLK` pins—Input support for differential standards. For I/O standard support, refer to Table 6–3 on page 6–11. When used as `DIFFCLK` pins, DC or AC coupling can be used depending on the interface requirements and external termination is required. For more information, refer to "High-Speed I/O Standards Support" on page 6–28.
- `REFCLK` pins—Input support for high speed differential reference clocks used by the transceivers in Cyclone IV GX devices. For I/O support, coupling, and termination requirements, refer to Table 6–10 on page 6–29.

In Cyclone IV devices, the DM pins are preassigned in the device pinouts. The Quartus II Fitter treats the DQ and DM pins in a DQS group equally for placement purposes. The preassigned DQ and DM pins are the preferred pins to use.

Some DDR2 SDRAM and DDR SDRAM devices support error correction coding (ECC), a method of detecting and automatically correcting errors in data transmission. In 72-bit DDR2 or DDR SDRAM, there are eight ECC pins and 64 data pins. Connect the DDR2 and DDR SDRAM ECC pins to a separate DQS or DQ group in Cyclone IV devices. The memory controller needs additional logic to encode and decode the ECC data.

Address and Control/Command Pins

The address signals and the control or command signals are typically sent at a single data rate. You can use any of the user I/O pins on all I/O banks of Cyclone IV devices to generate the address and control or command signals to the memory device.

☞ Cyclone IV devices do not support QDR II SRAM in the burst length of two.

Memory Clock Pins

In DDR2 and DDR SDRAM memory interfaces, the memory clock signals (CK and CK#) are used to capture the address signals and the control or command signals. Similarly, QDR II SRAM devices use the write clocks (K and K#) to capture the address and command signals. The CK/CK# and K/K# signals are generated to resemble the write-data strobe using the DDIO registers in Cyclone IV devices.

☞ CK/CK# pins must be placed on differential I/O pins (DIFFIO in Pin Planner) and in the same bank or on the same side as the data pins. You can use either side of the device for wraparound interfaces. As seen in the Pin Planner Pad View, CK0 cannot be located in the same row and column pad group as any of the interfacing DQ pins.

For more information about memory clock pin placement, refer to *Volume 2: Device, Pin, and Board Layout Guidelines* of the *External Memory Interface Handbook*.

Cyclone IV Devices Memory Interfaces Features

This section discusses Cyclone IV memory interfaces, including DDR input registers, DDR output registers, OCT, and phase-lock loops (PLLs).

DDR Input Registers

The DDR input registers are implemented with three internal logic element (LE) registers for every DQ pin. These LE registers are located in the logic array block (LAB) adjacent to the DDR input pin.

The first Cyclone IV device in the chain is the configuration master and it controls the configuration of the entire chain. Other Altera devices that support PS configuration can also be part of the chain as configuration slaves.

☞ In the multi-device AS configuration, the board trace length between the serial configuration device and the master device of the Cyclone IV device must follow the recommendations in Table 8–7 on page 8–18.

The nSTATUS and CONF_DONE pins on all target devices are connected together with external pull-up resistors, as shown in Figure 8–3 on page 8–13. These pins are open-drain bidirectional pins on the devices. When the first device asserts nCEO (after receiving all its configuration data), it releases its CONF_DONE pin. However, the subsequent devices in the chain keep this shared CONF_DONE line low until they receive their configuration data. When all target devices in the chain receive their configuration data and release CONF_DONE, the pull-up resistor drives a high level on CONF_DONE line and all devices simultaneously enter initialization mode.

☞ Although you can cascade Cyclone IV devices, serial configuration devices cannot be cascaded or chained together.

If the configuration bitstream size exceeds the capacity of a serial configuration device, you must select a larger configuration device, enable the compression feature, or both. When configuring multiple devices, the size of the bitstream is the sum of the individual device's configuration bitstream.

Configuring Multiple Cyclone IV Devices with the Same Design

Certain designs require that you configure multiple Cyclone IV devices with the same design through a configuration bitstream, or a **.sof**. You can do this through the following methods:

- Multiple **.sof**
- Single **.sof**

☞ For both methods, the serial configuration devices cannot be cascaded or chained together.

Multiple SRAM Object Files

Two copies of the **.sof** are stored in the serial configuration device. Use the first copy to configure the master device of the Cyclone IV device and the second copy to configure all remaining slave devices concurrently. All slave devices must have the same density and package. The setup is similar to Figure 8–3 on page 8–13.

To configure four identical Cyclone IV devices with the same **.sof**, you must set up the chain similar to the example shown in Figure 8–4. The first device is the master device and its MSEL pins must be set to select AS configuration. The other three slave devices are set up for concurrent configuration and their MSEL pins must be set to select PS configuration. The nCEO pin from the master device drives the nCE input pins on all three slave devices, as well as the DATA and DCLK pins that connect in parallel to all

Altera recommends putting a buffer before the DATA and DCLK output from the master device to avoid signal strength and signal integrity issues. The buffer must not significantly change the DATA-to-DCLK relationships or delay them with respect to other AS signals (ASDI and nCS). Also, the buffer must only drive the slave devices to ensure that the timing between the master device and the serial configuration device is unaffected.

This configuration method supports both compressed and uncompressed **.sof**. Therefore, if the configuration bitstream size exceeds the capacity of a serial configuration device, you can enable the compression feature in the **.sof** or you can select a larger serial configuration device.

Guidelines for Connecting a Serial Configuration Device to Cyclone IV Devices for an AS Interface

For single- and multi-device AS configurations, the board trace length and loading between the supported serial configuration device and Cyclone IV device must follow the recommendations listed in Table 8–7.

Table 8–7. Maximum Trace Length and Loading for AS Configuration

Cyclone IV Device AS Pins	Maximum Board Trace Length from a Cyclone IV Device to a Serial Configuration Device (Inches)		Maximum Board Load (pF)
	Cyclone IV E	Cyclone IV GX	
DCLK	10	6	15
DATA[0]	10	6	30
nCSO	10	6	30
ASDO	10	6	30

Note to Table 8–7:

(1) For multi-devices AS configuration using Cyclone IV E with 1,0 V core voltage, the maximum board trace-length from the serial configuration device to the junction-split on both DCLK and Data0 line is 3.5 inches.

Estimating AS Configuration Time

AS configuration time is dominated by the time it takes to transfer data from the serial configuration device to the Cyclone IV device. This serial interface is clocked by the Cyclone IV device DCLK output (generated from a 40-MHz internal oscillator for Cyclone IV E devices, a 20- or 40-MHz internal oscillator, or an external CLKUSR of up to 40 MHz for Cyclone IV GX devices).

Equation 8–2 and Equation 8–3 show the configuration time calculations.

Equation 8–2.

$$\text{Size} \times \left(\frac{\text{maximum DCLK period}}{\text{1 bit}}\right) = \text{estimated maximum configuration ti}$$

Equation 8–3.

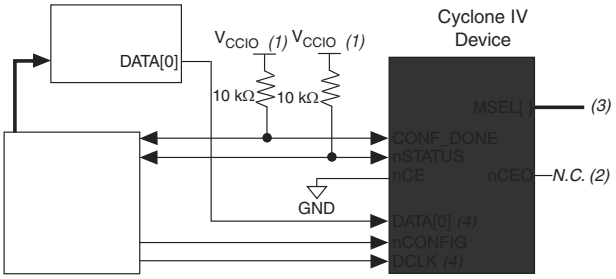
$$9{,}600{,}000 \text{ bits} \times \left(\frac{50 \text{ ns}}{\text{1 bit}}\right) = 480 \text{ ms}$$

PS Configuration Using an External Host

In the PS configuration scheme, you can use an intelligent host such as a MAX II device or microprocessor that controls the transfer of configuration data from a storage device, such as flash memory, to the target Cyclone IV device. You can store the configuration data in **.rbf**, **.hex**, or **.ttf** format.

Figure 8–13 shows the configuration interface connections between a Cyclone IV device and an external host device for single-device configuration.

Figure 8–13. Single-Device PS Configuration Using an External Host



Notes to Figure 8–13:

(1) Connect the pull-up resistor to a supply that provides an acceptable input signal for the device. V_{CC} must be high enough to meet the V_{IH} specification of the I/O on the device and the external host.

(2) The nCEO pin is left unconnected or used as a user I/O pin when it does not feed the nCE pin of another device.

(3) The MSEL pin settings vary for different configuration voltage standards and POR time. To connect the MSEL pins, refer to Table 8–3 on page 8–8, Table 8–4 on page 8–8, and Table 8–5 on page 8–9. Connect the MSEL pins directly to V_{CCA} or GND.

(4) All I/O inputs must maintain a maximum AC voltage of 4.1 V. DATA[0] and DCLK must fit the maximum overshoot outlined in Equation 8–1 on page 8–5.

To begin the configuration, the external host device must generate a low-to-high transition on the nCONFIG pin. When nSTATUS is pulled high, the external host device must place the configuration data one bit at a time on DATA[0]. If you use configuration data in **.rbf**, **.ttf**, or **.hex**, you must first send the LSB of each data byte. For example, if the **.rbf** contains the byte sequence 02 1B EE 01 FA, the serial bitstream you must send to the device is:

0100-0000 1101-1000 0111-0111 1000-0000 0101-1111

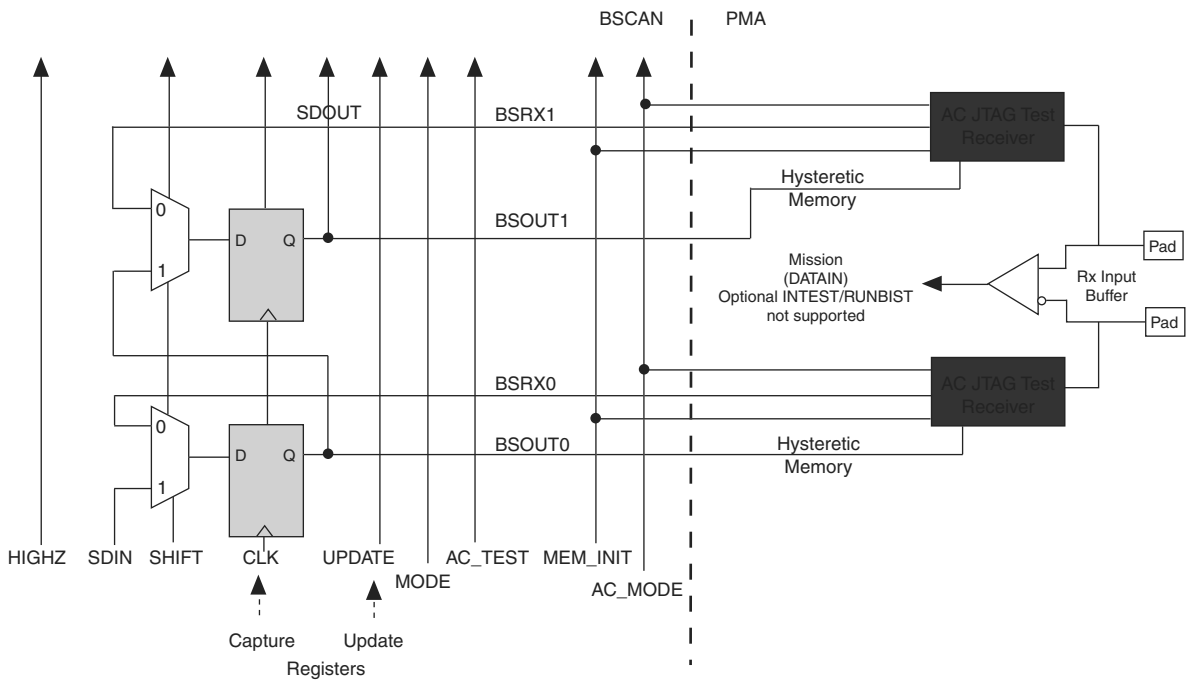
Cyclone IV devices receive configuration data on DATA[0] and the clock is received on DCLK. Data is latched into the device on the rising edge of DCLK. Data is continuously clocked into the target device until CONF_DONE goes high and the device enters initialization state.

☞ Two DCLK falling edges are required after CONF_DONE goes high to begin the initialization of the device.

INIT_DONE is released and pulled high when initialization is complete. The external host device must be able to detect this low-to-high transition which signals the device has entered user mode. When initialization is complete, the device enters user mode. In user mode, the user I/O pins no longer have weak pull-up resistors and function as assigned in your design.

Figure 10–2 shows the Cyclone IV GX HSSI receiver BSC.

Figure 10–2. HSSI Receiver BSC with IEEE Std. 1149.6 BST Circuitry for the Cyclone IV GX Devices



For more information about Cyclone IV devices user I/O boundary-scan cells, refer to the *IEEE 1149.1 (JTAG) Boundary-Scan Testing for Cyclone III Devices* chapter.

BST Operation Control

Table 10–1 lists the boundary-scan register length for Cyclone IV devices.

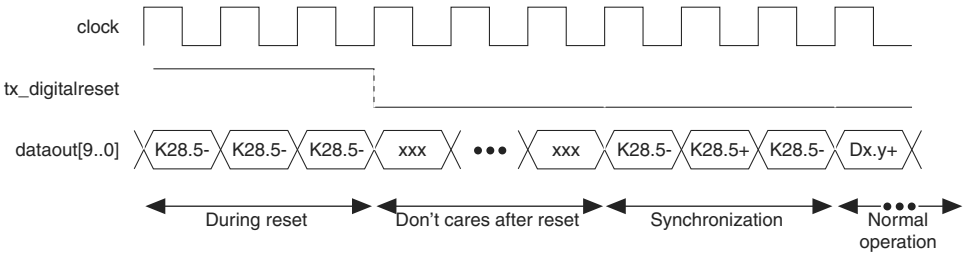
Table 10–1. Boundary-Scan Register Length for Cyclone IV Devices (Part 1 of 2)

Device	Boundary-Scan Register Length
EP4CE6	603
EP4CE10	603
EP4CE15	1080
EP4CE22	732
EP4CE30	1632
EP4CE40	1632
EP4CE55	1164
EP4CE75	1314
EP4CE115	1620
EP4CGX15	260
EP4CGX22	494
EP4CGX30 (1)	494
EP4CGX50	1006

The following describes the 8B/10B encoder behavior in reset condition (as shown in Figure 1–7):

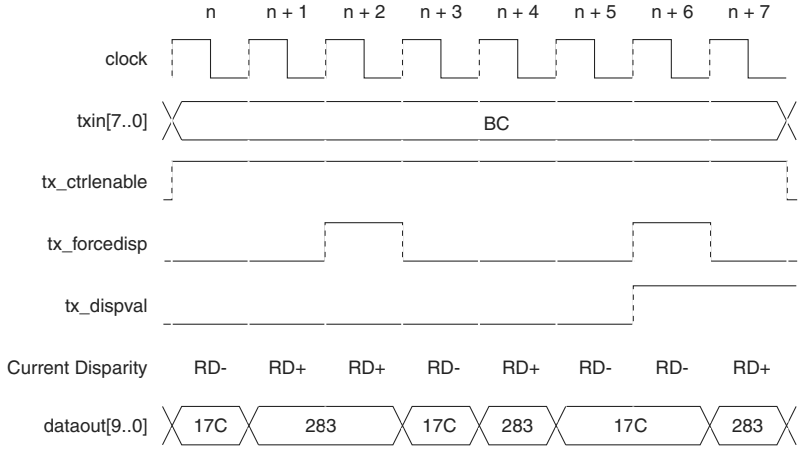
- During reset, the 8B/10B encoder ignores the inputs (`tx_datain` and `tx_ctrlenable` ports) from the FPGA fabric and outputs the K28.5 pattern from the RD- column continuously until the `tx_digitalreset` port is deasserted.
- Upon deassertion of the `tx_digitalreset` port, the 8B/10B encoder starts with a negative disparity and transmits three K28.5 code groups for synchronization before it starts encoding and transmitting data on its output.
- Due to some pipelining of the transmitter PCS, some "don't cares" (10'hxxx) are sent before the three synchronizing K28.5 code groups.

Figure 1–7. 8B/10B Encoder Behavior in Reset Condition



The encoder supports forcing the running disparity to either positive or negative disparity with `tx_forcedisp` and `tx_dispval` ports. Figure 1–8 shows an example of `tx_forcedisp` and `tx_dispval` port use, where data is shown in hexadecimal radix.

Figure 1–8. Force Running Disparity Operation



In this example, a series of K28.5 code groups are continuously sent. The stream alternates between a positive disparity K28.5 (RD+) and a negative disparity K28.5 (RD-) to maintain a neutral overall disparity. The current running disparity at time $n + 1$ indicates that the K28.5 in time $n + 2$ should be encoded with a negative disparity. Because `tx_forcedisp` is high at time $n + 2$, and `tx_dispval` is low, the K28.5

Clock Rate Compensation

In XAUI mode, the rate match FIFO compensates up to ±100 ppm (200 ppm total) difference between the upstream transmitter and the local receiver reference clock. The XAUI protocol requires the transmitter to send /R/ (/K28.0/) code groups simultaneously on all four lanes (denoted as ||R|| column) during inter-packet gaps, adhering to rules listed in the IEEE P802.3ae specification.

The rate match operation begins after `rx_syncstatus` and `rx_channelaligned` are asserted. The `rx_syncstatus` signal is from the word aligner, indicating that synchronization is acquired on all four channels, while `rx_channelaligned` signal is from the deskew FIFO, indicating channel alignment.

The rate match FIFO looks for the ||R|| column (simultaneous /R/ code groups on all four channels) and deletes or inserts ||R|| columns to prevent the rate match FIFO from overflowing or under running. The rate match FIFO can insert or delete as many ||R|| columns as necessary to perform the rate match operation.

The `rx_rmfifodatadeleted` and `rx_rmfifodatainserted` flags that indicate rate match FIFO deletion and insertion events, respectively, are forwarded to the FPGA fabric. If an ||R|| column is deleted, the `rx_rmfifodeleted` flag from each of the four channels goes high for one clock cycle per deleted ||R|| column. If an ||R|| column is inserted, the `rx_rmfifoinserted` flag from each of the four channels goes high for one clock cycle per inserted ||R|| column.

☞ The rate match FIFO does not insert or delete code groups automatically to overcome FIFO empty or full conditions. In this case, the rate match FIFO asserts the `rx_rmfifofull` and `rx_rmfifoempty` flags for at least three recovered clock cycles to indicate rate match FIFO full and empty conditions, respectively. You must then assert the `rx_digitalreset` signal to reset the receiver PCS blocks.

Deterministic Latency Mode

Deterministic Latency mode provides the transceiver configuration that allows no latency uncertainty in the datapath and features to strictly control latency variation. This mode supports non-bonded (×1) and bonded (×4) channel configurations, and is typically used to support CPRI and OBSAI protocols that require accurate delay measurements along the datapath. The Cyclone IV GX transceivers configured in Deterministic Latency mode provides the following features:

- registered mode phase compensation FIFO
- receive bit-slip indication
- transmit bit-slip control
- PLL PFD feedback

Document Revision History

Table 1–30 lists the revision history for this chapter.

Table 1–30. Document Revision History

Date	Version	Changes
February 2015	3.7	■ Updated the GiGE row in Table 1–14. ■ Updated the "GIGE Mode" section. ■ Updated the note in the "Clock Frequency Compensation" section.
October 2013	3.6	Updated Figure 1–15 and Table 1–4.
May 2013	3.5	Updated Table 1–27 by setting "rx_locktodata" and "rx_locktorefclk" to "Input"
October 2012	3.4	■ Updated the data rate for the V-by-one protocol and the F324 package support in HD-SDI in Table 1–1. ■ Updated note (1) to Figure 1–27. ■ Added latency information to Figure 1–67.
November 2011	3.3	■ Updated "Word Aligner" and "Basic Mode" sections. ■ Updated Figure 1–37.
December 2010	3.2	■ Updated for the Quartus II software version 10.1 release. ■ Updated Table 1–1, Table 1–5, Table 1–11, Table 1–14, Table 1–24, Table 1–25, Table 1–26, Table 1–27, Table 1–28, and Table 1–29. ■ Updated "8B/10B Encoder", "Transmitter Output Buffer", "Receiver Input Buffer", "Clock Data Recovery", "Miscellaneous Transmitter PCS Features", "Miscellaneous Receiver PCS Feature", "Input Reference Clocking", "PCI Express (PIPE) Mode", "Channel Deskewing", "Lane Synchronization", "Serial Loopback", and "Self Test Modes" sections. ■ Added Figure 1–9, Figure 1–10, Figure 1–19, Figure 1–20, and Figure 1–43. ■ Updated Figure 1–53, Figure 1–55, Figure 1–59, Figure 1–60, Figure 1–69, Figure 1–70, Figure 1–71, Figure 1–72, Figure 1–73, and Figure 1–74.
November 2010	3.1	Updated Introductory information.
July 2010	3.0	■ Updated information for the Quartus II software version 10.0 release. ■ Reset control, power down, and dynamic reconfiguration information moved to new *Cyclone IV Reset Control and Power Down* and *Cyclone IV Dynamic Reconfiguration* chapters.

Table 3–2. Dynamic Reconfiguration Controller Port List (ALTGX_RECONFIG Instance) (Part 4 of 7)

<table>
<tr><th>Port Name</th><th>Input/ Output</th><th>Description</th></tr>
<tr><td colspan="3">Analog Settings Control/Status Signals</td></tr>
<tr><td>tx_vodctrl[2..0] (1)</td><td>Input</td><td>This is an optional transmit buffer V_{OD} control signal. It is 3 bits per transmitter channel. The number of settings varies based on the transmit buffer supply setting and the termination resistor setting on the TX Analog screen of the ALTGX MegaWizard Plug-In Manager.

The width of this signal is fixed to 3 bits if you enable either the Use 'logical_channel_address' port for Analog controls reconfiguration option or the Use same control signal for all the channels option in the Analog controls screen. Otherwise, the width of this signal is 3 bits per channel.

The following shows the V_{OD} values corresponding to the tx_vodctrl settings for 100-Ω termination.

For more information, refer to the “Programmable Output Differential Voltage” section of the Cyclone IV GX Device Datasheet chapter.
<table>
<tr><th>tx_vodctrl[2:0]</th><th>Corresponding ALTGX instance settings</th><th>Corresponding V_{OD} settings (mV)</th></tr>
<tr><td>3’b001</td><td>1</td><td>400</td></tr>
<tr><td>3’b010</td><td>2</td><td>600</td></tr>
<tr><td>3’b011</td><td>3</td><td>800</td></tr>
<tr><td>3’b111</td><td>4 (2)</td><td>900 (2)</td></tr>
<tr><td>3’b100</td><td>5</td><td>1000</td></tr>
<tr><td>3’b101</td><td>6</td><td>1200</td></tr>
<tr><td colspan="3">All other values => N/A</td></tr>
</table>
</td></tr>
</table>

Table 3–4 describes the tx_datainfull[21..0] FPGA fabric-transceiver channel interface signals.

Table 3–4. tx_datainfull[21..0] FPGA Fabric-Transceiver Channel Interface Signal Descriptions (1)

FPGA Fabric-Transceiver Channel Interface Description	Transmit Signal Description (Based on Cyclone IV GX Supported FPGA Fabric-Transceiver Channel Interface Widths)
8-bit FPGA fabric-Transceiver Channel Interface	tx_datainfull[7:0]: 8-bit data (tx_datain)
	The following signals are used only in 8B/10B modes:
	tx_datainfull[8]: Control bit (tx_ctrlenable)
	tx_datainfull[9] Transmitter force disparity Compliance (PCI Express [PIPE]) (tx_forcedisp) in all modes except PCI Express (PIPE) functional mode. For PCI Express (PIPE) functional mode, (tx_forcedispcompliance) is used.
	■ For non-PIPE: tx_datainfull[10]: Forced disparity value (tx_dispval) ■ For PCIe: tx_datainfull[10]: Forced electrical idle (tx_forceelecidle)
10-bit FPGA fabric-Transceiver Channel Interface	tx_datainfull[9:0]: 10-bit data (tx_datain)
16-bit FPGA fabric-Transceiver Channel Interface with PCS-PMA set to 8/10 bits	Two 8-bit Data (tx_datain) tx_datainfull[7:0] - tx_datain (LSByte) and tx_datainfull[18:11] - tx_datain (MSByte)
	The following signals are used only in 8B/10B modes:
	tx_datainfull[8] - tx_ctrlenable (LSB) and tx_datainfull[19] - tx_ctrlenable (MSB)
	Force Disparity Enable ■ For non-PIPE: tx_datainfull[9] - tx_forcedisp (LSB) and tx_datainfull[20] - tx_forcedisp (MSB) ■ For PCIe: tx_datainfull[9] - tx_forcedispcompliance and tx_datainfull[20] - 0
	Force Disparity Value ■ For non-PIPE: tx_datainfull[10] - tx_dispval (LSB) and tx_datainfull[21] - tx_dispval (MSB) ■ For PCIe: tx_datainfull[10] - tx_forceelecidle and tx_datainfull[21] - tx_forceelecidle
20-bit FPGA fabric-Transceiver Channel Interface with PCS-PMA set to 10 bits	Two 10-bit Data (tx_datain) tx_datainfull[9:0] - tx_datain (LSByte) and tx_datainfull[20:11] - tx_datain (MSByte)

Note to Table 3–4:

(1) For all transceiver-related ports, refer to the "Transceiver Port Lists" section in the *Cyclone IV GX Transceiver Architecture* chapter.

1. Cyclone IV Device Datasheet

CYIV-53001-2.1

This chapter describes the electrical and switching characteristics for Cyclone® IV devices. Electrical characteristics include operating conditions and power consumption. Switching characteristics include transceiver specifications, core, and periphery performance. This chapter also describes I/O timing, including programmable I/O element (IOE) delay and programmable output buffer delay.

This chapter includes the following sections:

Operating Conditions

When Cyclone IV devices are implemented in a system, they are rated according to a set of defined parameters. To maintain the highest possible performance and reliability of Cyclone IV devices, you must consider the operating requirements described in this chapter.

Cyclone IV devices are offered in commercial, industrial, extended industrial and, automotive grades. Cyclone IV E devices offer –6 (fastest), –7, –8, –8L, and –9L speed grades for commercial devices, –8L speed grades for industrial devices, and –7 speed grade for extended industrial and automotive devices. Cyclone IV GX devices offer –6 (fastest), –7, and –8 speed grades for commercial devices and –7 speed grade for industrial devices.

For more information about the supported speed grades for respective Cyclone IV devices, refer to the *Cyclone IV FPGA Device Family Overview* chapter.

Cyclone IV E devices are offered in core voltages of 1.0 and 1.2 V. Cyclone IV E devices with a core voltage of 1.0 V have an 'L' prefix attached to the speed grade.

In this chapter, a prefix associated with the operating temperature range is attached to the speed grades; commercial with a "C" prefix, industrial with an "I" prefix, and automotive with an "A" prefix. Therefore, commercial devices are indicated as C6, C7, C8, C8L, or C9L per respective speed grade. Industrial devices are indicated as I7, I8, or I8L. Automotive devices are indicated as A7.